

SANYO Semiconductors DATA SHEET

2SK3702JS-

N-Channel Silicon MOSFET

General-Purpose Switching Device Applications

Features

- · Low ON-resistance.
- · Ultrahigh-speed switching.
- · 4V drive.
- · Avalanche resistance guarantee.
- · Pb-free type.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Drain-to-Source Voltage	VDSS		60	V
Gate-to-Source Voltage	VGSS		±20	V
Drain Current (DC)	ID		18	Α
Drain Current (Pulse)	IDP	PW≤10μs, duty cycle≤1%	72	Α
Allowable Power Dissipation	D-		2.0	W
	PD	Tc=25°C	20	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C
Avalanche Energy (Single Pulse) *1	EAS		23	mJ
Avalanche Current *2	I _{AV}		18	Α

Note: *1 V_{DD}=20V, L=100μH, I_{AV}=18A

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
Drain-to-Source Breakdown Voltage	V(BR)DSS	I _D =1mA, V _{GS} =0V	60			V
Zero-Gate Voltage Drain Current	IDSS	VDS=60V, VGS=0V			1	μΑ
Gate-to-Source Leakage Current	IGSS	V _{GS} = ±16V, V _{DS} =0V			±10	μΑ
Cutoff Voltage	VGS(off)	V _{DS} =10V, I _D =1mA	1.2		2.6	V
Forward Transfer Admittance	yfs	V _{DS} =10V, I _D =9A	8	12		S
Static Drain-to-Source On-State Resistance	R _{DS} (on)1	I _D =9A, V _G S=10V		42	55	mΩ
	R _{DS} (on)2	I _D =9A, V _G S=4V		60	85	mΩ

Marking: K3702 Continued on next page.

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^{*2} L≤100µH, Single pulse

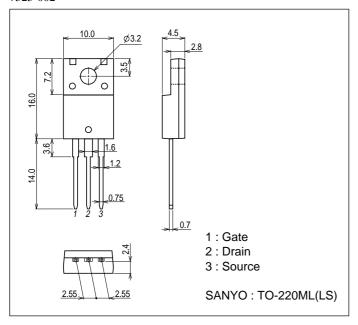
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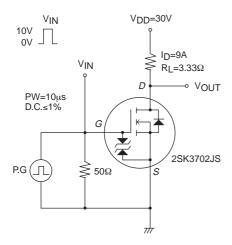
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
Input Capacitance	Ciss	V _{DS} =20V, f=1MHz		775		pF
Output Capacitance	Coss	V _{DS} =20V, f=1MHz		125		pF
Reverse Transfer Capacitance	Crss	V _{DS} =20V, f=1MHz		105		pF
Turn-ON Delay Time	t _d (on)	See specified Test Circuit.		11		ns
Rise Time	t _r	See specified Test Circuit.		65		ns
Turn-OFF Delay Time	t _d (off)	See specified Test Circuit.		75		ns
Fall Time	tf	See specified Test Circuit.		70		ns
Total Gate Charge	Qg	V _{DS} =30V, V _{GS} =10V, I _D =18A		19		nC
Gate-to-Source Charge	Qgs	V _{DS} =30V, V _{GS} =10V, I _D =18A		2.5		nC
Gate-to-Drain "Miller" Charge	Qgd	V _{DS} =30V, V _{GS} =10V, I _D =18A		4.1		nC
Diode Forward Voltage	V _{SD}	I _S =18A, V _{GS} =0V		0.98	1.2	V

Package Dimensions

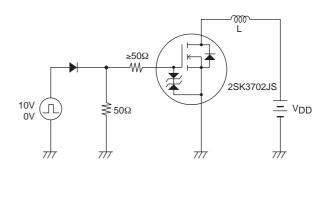
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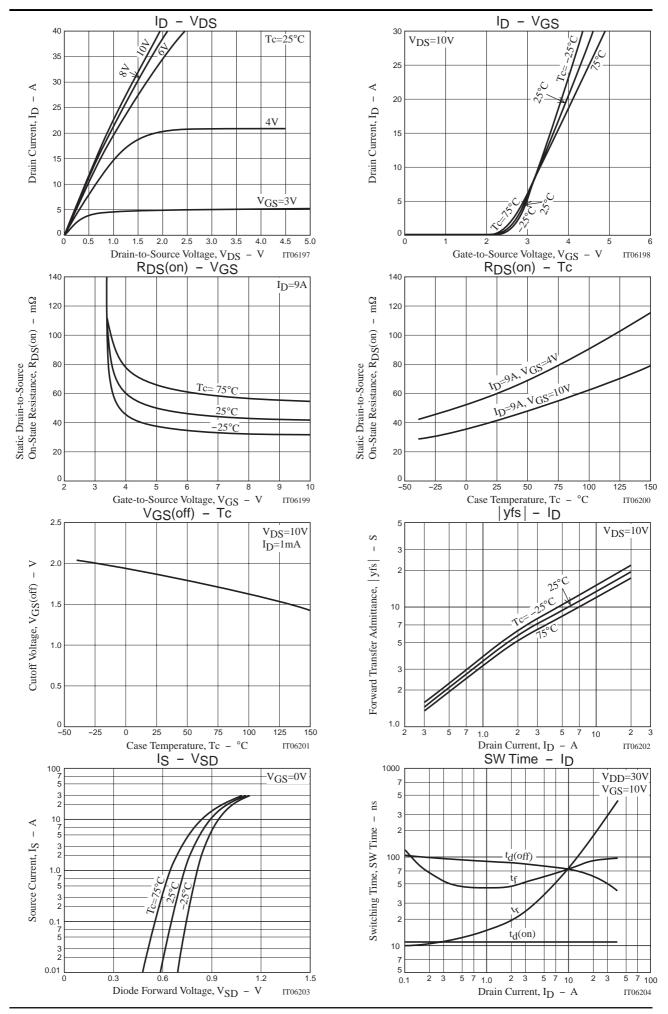


Switching Time Test Circuit

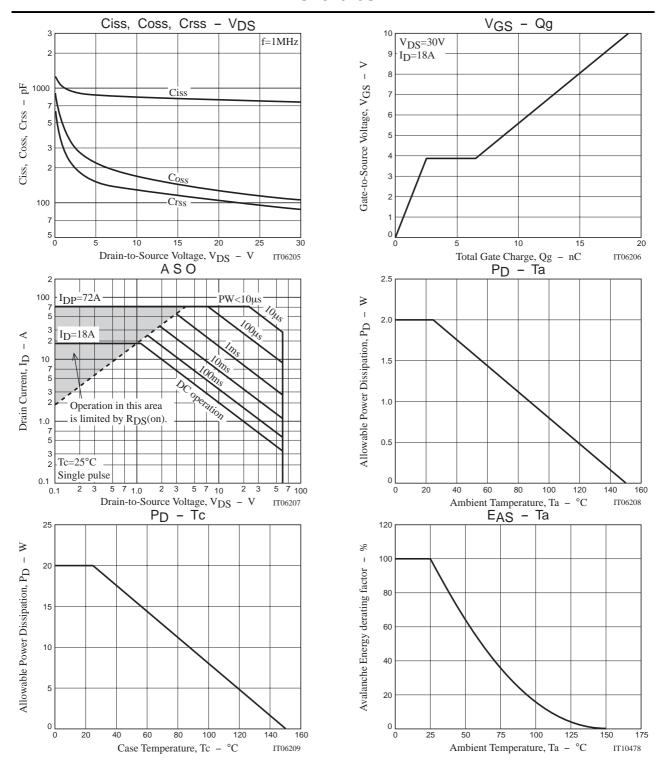


Avalanche Resistance Test Circuit





2SK3702JS



Note on usage: Since the 2SK3702JS is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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